PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data		
1.1 Company		STMicroelectronics International N.V
1.2 PCN No.		IPD/15/9230
1.3 Title of PCN		Die optimization for STPSCxxH065xx / STPSCxxH065xxY and STPSCxxTH13TI
1.4 Product Category		STPSCxxH065xx / STPSCxxH065xxY and STPSCxxTH13TI
1.5 Issue date		2015-05-11

2. PCN Team		
2.1 Contact supplier		
2.1.1 Name	MARSHALL DAVE	
2.1.2 Phone		
2.1.3 Email	dave.marshall@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Franck DUCLOS	
2.1.2 Marketing Manager	Eric PARIS	
2.1.3 Quality Manager	Jean-Paul REBRASSE	

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Wafer Fab (Process)	(Not Defined)	Catania wafer fab

4. Description of change		
	Old	New
4.1 Description	n/a	STMicroelectronics is now going to implement the new die optimization layout for its H series rectifier products in SiC 650V technology.
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	no	

5. Reason / motivation for change		
5.1 Motivation This change enhances ST's competitiveness in SiC market by improving our posprice/performances.		
5.2 Customer Benefit	SERVICE IMPROVEMENT	

6. Marking of parts / traceability of change	
6.1 Description	internal codifications and QA number

7. Timing / schedule	
7.1 Date of qualification results	2015-05-04
7.2 Intended start of delivery	2015-07-01
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation			
8.1 Description			
8.2 Qualification report and qualification results	In progress	Issue Date	

	9. Attachments (additional documentations)
9230PpPrdtLst.pdf PCN_SiC Rectifiers_die optimization.pdf	

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No 10.1.2 Supplier Part No		10.1.2 Supplier Part No
	STPSC10H065B-TR	

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